

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Sung Dae CHO  
Assignee: Samsung Electronics Co., Ltd.  
Title: Reel-Deployed Printed Circuit Board For Manufacturing Chip-On-Board Packages  
Serial No.: Not Yet Assigned Filing Date: April 5, 2001  
Examiner: Not Yet Assigned Group Art Unit: 1765  
Docket No.: AB-698-1D US

Newport Beach, California  
April 5, 2001

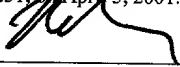
COMMISSIONER FOR PATENTS  
Washington, D. C. 20231

**PRELIMINARY AMENDMENT**

Dear Sir:

Please cancel claims 10-20.


I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on April 5, 2001.

  
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Attorney for Applicant(s)

April 5, 2001  
Date of Signature

Express Mail No. EL661591824US

Respectfully submitted,

  
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